

SD-Wi-Fi-FP91-88W8977

## Firmware Release Notes for FreeRTOS



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## Revision History

Table 1: Document revision history

Revision	Date	Change details
Rev. 1	17-Jul-2020	Initial release
Rev. 2	30-Nov-2020	<ul style="list-style-type: none"><li>Updated Release Version.</li><li>Added WLAN Certification section and EU Conformance tests</li></ul>
Rev. 3	05-Jan-2021	<ul style="list-style-type: none"><li>Updated Release Version and Bug Fixes/Enhancement section.</li></ul>
Rev.4	07-July-2021	<ul style="list-style-type: none"><li><a href="#">Section 1</a> and <a href="#">Section 2</a> updated</li><li><a href="#">Section 7</a> updated</li></ul>
Rev. 5	27-Aug-2021	<ul style="list-style-type: none"><li><a href="#">Section 1</a> updated</li><li><a href="#">Section 5</a> updated</li></ul>
Rev. 6	05-Jan-2022	<ul style="list-style-type: none"><li><a href="#">Section 1</a> and <a href="#">Section 2</a> updated</li><li><a href="#">Section 7</a> updated</li></ul>

## 1 Package Information

- SDK version: 2.11.0
- Wi-Fi firmware version: 16.91.10.p186.1

Please refer to the Software feature list in the document: *SD-Wi-Fi-FP91-88W8977-Wi-Fi-Software-Features-for-FreeRTOS*

## 2 Firmware Version Information

- Wireless SoC : 88W8977
- Wi-Fi Firmware version : 16.91.10.p186.1
  - 16 - Major revision
  - 91 - Feature pack
  - 10 - Release version
  - p186.1 - Patch number

### 3 Host Platform

- All i.MX RT Platform running FreeRTOS
- Interface used
  - Wi-Fi over SDIO (SDIO 2.0 support, SDIO clock frequency: up to 50 MHz)

#### Test Tools

- iperf (version 2.0.5)

## 4 Wi-Fi Certifications

The Wi-Fi certification is obtained with the following combinations.

### 4.1 WFA Certifications

- STA | 802.11n
- STA | PMF

Refer *TN00066-WFA Derivative Certification Process* document available in SDK Package.

## 5 Wi-Fi Throughput

### 5.1 Throughput Test Setup

- Environment: Shield Room - Over the Air
- Access Point: Netgear RAX120
- DUT: 88W8977-Panasonic (Module : **PAN9026-uSD**, SDIO Clock Frequency: 25 MHz) with RT1060 platform
- Client: OnePlus 6T
- Channel: 6 | 36

Refer to **Section-3.1.1** in *UM11442-NXP Wi-Fi and Bluetooth Demo Applications User Guide for i.MX RT Platforms* to read more about the throughput test setup and topology.

### 5.2 STA Throughput

External AP: Netgear RAX120

STA Mode Throughput - BGN Mode   2.4 GHz Band   20 MHz				
Protocol	TCP (Mbit/s)		UDP (Mbit/s)	
Direction	Tx	Rx	Tx	Rx
Open Security	18	19	38	46
WPA2-AES	17	18	38	45
WPA3-SAE	20	22	32	47

STA Mode Throughput - AN Mode   5 GHz Band   20 MHz				
Protocol	TCP (Mbit/s)		UDP (Mbit/s)	
Direction	Tx	Rx	Tx	Rx
Open Security	23	25	37	51
WPA2-AES	22	25	35	50
WPA3-SAE	24	24	47	50

STA Mode Throughput - AN Mode   5 GHz Band   40 MHz				
Protocol	TCP (Mbit/s)		UDP (Mbit/s)	
Direction	Tx	Rx	Tx	Rx
Open Security	22	27	47	50
WPA2-AES	21	26	46	50
WPA3-SAE	28	26	46	49



### 5.3 Mobile AP Throughput

External client: OnePlus6T

Mobile AP Mode Throughput - BGN Mode   2.4 GHz Band   20MHz				
Protocol	TCP (Mbit/s)		UDP (Mbit/s)	
Direction	Tx	Rx	Tx	Rx
Open Security	22	25	37	45
WPA2-AES	19	22	35	44
WPA3-SAE	24	28	39	44

Mobile AP Mode Throughput - AN Mode   5 GHz Band   20 MHz				
Protocol	TCP (Mbit/s)		UDP (Mbit/s)	
Direction	Tx	Rx	Tx	Rx
Open Security	24	23	46	47
WPA2-AES	21	20	45	47
WPA3-SAE	25	27	46	48

Mobile AP Mode Throughput - AN Mode   5 GHz Band   40 MHz				
Protocol	TCP (Mbit/s)		UDP (Mbit/s)	
Direction	Tx	Rx	Tx	Rx
Open Security	24	22	46	47
WPA2-AES	23	21	46	46
WPA3-SAE	28	29	43	47

## 6 EU Conformance tests

- EU Adaptivity test - EN 300 328 v2.1.1 (for 2.4 GHz)
- EU Adaptivity test - EN 301 893 v2.1.1 (for 5 GHz)

## 7 Bug Fixes/Feature Enhancements

Component	Description
Wi-Fi	<ul style="list-style-type: none"><li>• Added support for WPA3 R3 security</li></ul>

## 8 Known Issues

Component	Description
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## 9 Notes

- None

## 10 Legal Information

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